

Metallizations in Microelectronics

Chemical etchants compatible with negative and positive photoresists for developing ohmic contacts and interconnections in integrated circuits, transistors, diodes, MOD and FET devices.

ALUMINUM ETCHANT TYPE A

DESCRIPTION:

Standard aluminum etchant for use on silicon devices and other microelectronic applications

FEATURES:

- Controlled etch rates
- Selective etching: will not attack SiO2
- Offers high resolution with minimal undercutting
- Eliminates smut formation
- Economical; reusable





ALUMINUM ETCHANTS

DESCRIPTION:

Aluminum Etchants are stable, non-toxic preparations used to etch aluminum metallizations on silicon devices and in integrated circuit applications. Aluminum contacts are defined and interconnections are formed. These Aluminum Etchants formulated with unique properties easily overcome many of the difficulties experienced in aluminum etch processes.

The aluminum metallization and etching process using photo-lithographic techniques is basic to the semiconductor and microelectronic technology. Aluminum Etchants are highly compatible with commercial photoresists (KTFR, AZ, Hunt, Waycoat, etc.) and permit delineation into high resolution patterns. Metal line width of 1 mil and separations less than 5 microns are feasible. The high resolution is practical with Aluminum Etchants because lifting of photoresist patterns does not occur and undercutting is minimized. Furthermore, the etchants do not attack silicon, silicon dioxide, silicon nitride or nichrome resistor films.

Type A is recommended for use on silicon devices.

APPLICATION:

Aluminum metallizations up to 25,000Å are vacuum deposited on the silicon slice, coated with a photoresist, and UV exposed using an appropriate photographic mask. The resist is developed to protect the aluminum where interconnections are desired. Then the unprotected areas of the aluminum are removed by etching with Aluminum Etchant, followed by a water rinse.

Etching time is dependent upon the etchant temperature and the aluminum film thickness. When etching thick aluminum films, a higher etch rate is required; thus a higher etchant temperature should be used. Likewise, for thinner aluminum films, slower etch rates are desired and a lower etchant temperature should be chosen. At a specific etchant temperature, the etching time is given by the following formula:

> Etching time (second) + <u>Film Thickness (Å)</u> Etch Rate (Å/sec)



PROPERTIES OF ALUMINUM ETCHANT TYPE A

| How do I increase the etch rate? | 1. The rate will approximately double with every 10 |
|---------------------------------------|------------------------------------------------------------------------------------------------------|
| | oC increase in temperature. |
| How do I reduce the atchrate? | 2. Increase the rate of stiffing of agitation. |
| | the etch rate approximately 50% |
| | |
| Do I need to dilute the etchant? | No, it is ready to use. |
| How do I reduce undercutting? | Increase the rate of stirring or agitation. |
| Appearance | Water-white to light yellow |
| рН | Strong Acid |
| Etch Rate at 25 oC | 30 Å/second |
| At 40 oC | 80 Å/second |
| Etch Capacity (rate declines at ~70%) | 60 g/gallon |
| ShelfLife | 1 year |
| Storage Conditions | Ambient |
| Filtration | 212121212m |
| Recommended Operating Temperatures | 20-80 oC (30-40 oC most common) |
| Rinse | Deionized water; may be followed by a lcohol rinse if desired. |
| Photore sist Recommendations | KLT6000 Series, KLT 5300 Series, HARE SQT (SU-8 type), TRANSIST, or PKP II |
| Select Compatible Materials | SiO2, Au, NiCr, Nb, Pt, Ti, W |
| Select Incompatible Materials | Al , Al 2O3, Si 3N4, C, Co, Cr, Cu, Fe , Ga As, Mg, MgO, Ni , Pd , Ru , Si , Steel , Ta/TaN , ZnO |
| Compatible Plastics | HDPE, PP, Teflon, PFA, PVC |
| Country of Origin | USA |
| Packaging | HDPE |
| Isotropy | Isotropic |
| Incompatible Chemicals | Strong Bases |
| Additional Information | |

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